### High Frequency Timing-Safe™ Peak EMI reduction IC

#### **General Features**

- High Frequency Clock distribution with Timing-Safe™ Peak EMI Reduction
- Input frequency range: 100MHz 175MHz
- Multiple low skew Timing-safe<sup>™</sup> Outputs: PCS3P625Z05: 5 Outputs

PCS3P625Z09: 9 Outputs

- External Input-Output Delay Control option
- Supply Voltage: 3.3V±0.3V
- Commercial and Industrial temperature range
- Packaging Information:
   ASM3P625Z05: 8 pin SOIC, and TSSOP
   ASM3P625Z09:16 pin SOIC, and TSSOP
- True Drop-in Solution for Zero Delay Buffer, ASM5P2305A / 09A

#### **Functional Description**

PCS3P625Z05/09 is a versatile, 3.3V Zero-delay buffer designed to distribute high frequency Timing-Safe™ clocks

#### **General Block Diagram**

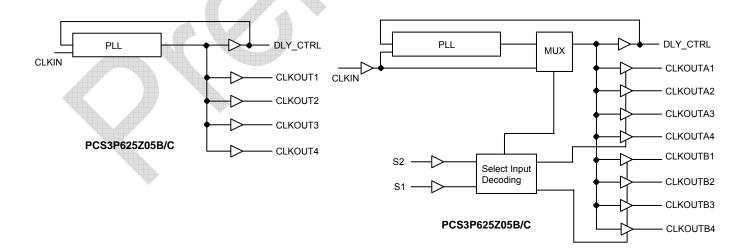
with Peak EMI reduction. PCS3P625Z05 is an eight-pin version, accepts one reference input and drives out five low-skew Timing-Safe™ clocks. PCS3P625Z09 accepts one reference input and drives out nine low-skew Timing-Safe™clocks.

PCS3P625Z05/09 has a DLY\_CTRL for adjusting the Input-Output clock delay, depending upon the value of capacitor connected at this pin to GND.

PCS3P625Z05/09 operates from a 3.3V supply and is available in two different packages, as shown in the ordering information table, over commercial and Industrial temperature range.

#### **Application**

PCS3P625Z05/09 is targeted for use in Displays and memory interface systems.





#### **Spread Spectrum Frequency Generation**

The clocks in digital systems are typically square waves with a 50% duty cycle and as frequencies increase the edge rates also get faster. Analysis shows that a square wave is composed of fundamental frequency and harmonics. The fundamental frequency and harmonics generate the energy peaks that become the source of EMI. Regulatory agencies test electronic equipment by measuring the amount of peak energy radiated from the equipment. In fact, the peak level allowed decreases as the frequency increases. The standard methods of reducing EMI are to use shielding, filtering, multi-layer

PCBs etc. These methods are expensive. Spread spectrum clocking reduces the peak energy by reducing the Q factor of the clock. This is done by slowly modulating the clock frequency. The PCS3P625Z05/09 uses the center modulation spread spectrum technique in which the modulated output frequency varies above and below the reference frequency with a specified modulation rate. With center modulation, the average frequency is the same as the unmodulated frequency and there is no performance degradation

#### Zero Delay and Skew Control

All outputs should be uniformly loaded to achieve Zero Delay between input and output. Since the DLY\_CTRL pin is the internal feedback to the PLL, its relative loading can adjust the input-output delay.

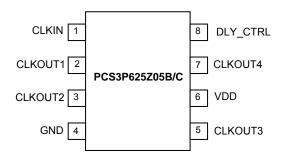
For applications requiring zero input-output delay, all outputs, including DLY\_CTRL, must be equally loaded. Even if DLY\_CTRL is not used, it must have a capacitive load equal to that on other outputs, for obtaining zero-input-output delay.

#### Timing-Safe™ technology

Timing-Safe™ technology is the ability to modulate a clock source with Spread Spectrum technology and maintain synchronization with any associated data path.



# Pin Configuration for PCS3P625Z05B/C

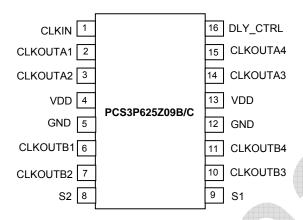


# Pin Description for PCS3P625Z05B/C

Pin#	Pin Name	Туре	Description
1	CLKIN <sup>1</sup>	I	External reference Clock input, 5V tolerant input
2	CLKOUT1 <sup>2</sup>	0	Buffered clock output <sup>4</sup>
3	CLKOUT2 <sup>2</sup>	0	Buffered clock output <sup>4</sup>
4	GND	Р	Ground
5	CLKOUT3 <sup>2</sup>	0	Buffered clock output <sup>4</sup>
6	VDD	P	3.3V supply
7	CLKOUT4 <sup>2</sup>	0	Buffered clock output <sup>4</sup>
8	DLY_CTRL	0	External Input-Output Delay control. This pin can be used as clock output <sup>4</sup>



### Pin Configuration for PCS3P625Z09B/C



## Pin Description for PCS3P625Z09B/C

Pin#	Pin Name	Pin Type	Description
1	CLKIN <sup>1</sup>	I	External reference Clock input, 5V tolerant input
2	CLKOUTA1 <sup>2</sup>	0	Buffered clock Bank A output <sup>4</sup>
3	CLKOUTA2 <sup>2</sup>	0	Buffered clock Bank A output⁴
4	VDD	Р	3.3V supply
5	GND	Р	Ground
6	CLKOUTB1 <sup>2</sup>	0	Buffered clock Bank B output <sup>4</sup>
7	CLKOUTB2 <sup>2</sup>	0	Buffered clock Bank B output <sup>4</sup>
8	S2 <sup>3</sup>		Select input, bit 2.See Select Input Decoding table for PCS3P625Z09 for more details
9	S1 <sup>3</sup>	ı	Select input, bit 1.See Select Input Decoding table for PCS3P625Z09 for more details
10	CLKOUTB3 <sup>2</sup>	0	Buffered clock Bank B output <sup>4</sup>
11	CLKOUTB4 <sup>2</sup>	0	Buffered clock Bank B output <sup>4</sup>
12	GND	Р	Ground
13	VDD	Р	3.3V supply
14	CLKOUTA3 <sup>2</sup>	0	Buffered clock Bank A output <sup>4</sup>
15	CLKOUTA4 <sup>2</sup>	0	Buffered clock Bank A output <sup>4</sup>
16	DLY_CTRL <sup>2</sup>	0	External Input-Output Delay control. This pin can be used as clock output

Notes: 1. Weak pull down

- Weak pull-down on all outputs
   Weak pull-up on these Inputs
   Buffered clock output is Timing-Safe™



# Select Input Decoding table for PCS3P625Z09

<b>S</b> 2	S1	CLKOUT A1 - A4	CLKOUT B1 - B4	DLY_CTRL1	Output Source	PLL Shut-Down
0	0	Three-state	Three-state	Driven	PLL	N
0	1	Driven	Three-state	Driven	PLL	N
1	0	Driven	Driven	Driven	Reference	Y
1	1	Driven	Driven	Driven	PLL	N

Notes: This output is driven and has an internal feedback for the PLL. The load on this output can be adjusted to change the skew between the reference and the Output.

# **Spread Spectrum Control and Input-Output Skew Table**

Frequency (MHz)	Device	Deviation (±%)	Input-Output Skew (±T <sub>SKEW</sub> )
	PCS3P625Z05B / 09B	0.25	0.0625
140	PCS3P625Z05C / 09C	0.5	0.125

Note: T<sub>SKEW</sub> is measured in units of the Clock Period

#### **Absolute Maximum Ratings**

V
v
°C
°C
°C
KV
0

### **Operating Conditions**

Parameter	Description	Min	Max	Unit
VDD	Supply Voltage	3.0	3.6	V
T <sub>A</sub>	Operating Temperature (Ambient Temperature)	-40	+85	°C
$C_L$	Load Capacitance		10	pF
$C_{IN}$	Input Capacitance		7	pF



#### **Electrical Characteristics**

Parameter	Description	Test Conditions	Min	Тур	Max	Unit
$V_{IL}$	Input LOW Voltage <sup>5</sup>				0.8	V
V <sub>IH</sub>	Input HIGH Voltage <sup>5</sup>		2.0		4	V
I <sub>IL</sub>	Input LOW Current	$V_{IN} = 0V$			50	μA
I <sub>IH</sub>	Input HIGH Current	V <sub>IN</sub> = VDD			100	μA
$V_{OL}$	Output LOW Voltage <sup>6</sup>	I <sub>OL</sub> = 8mA			0.4	V
$V_{OH}$	Output HIGH Voltage <sup>6</sup>	I <sub>OH</sub> = -8mA	2.4			V
$I_{DD}$	Dynamic Supply Current	Unloaded outputs			65	mA
Zo	Output Impedance	_		23		Ω

## **Switching Characteristics**

Parameter	Test Conditions	Min	Тур	Max	Unit
Input Frequency		100		175	MHz
Output Frequency	10pF load	100		175	MHz
Duty Cycle $^{7,8} = (t_2/t_1) * 100$	Measured at VDD/2	40	50	60	%
Output Rise Time 7,8	Measured between 0.8V and 2.0V			2.5	nS
Output Fall Time <sup>7, 8</sup>	Measured between 2.0V and 0.8V			2.5	nS
Output-to-output skew 7,8	All outputs equally loaded			250	pS
Delay, CLKIN Rising Edge to CLKOUT Rising Edge <sup>8</sup>	Measured at VDD /2			±350	pS
Device-to-Device Skew <sup>8</sup>	Measured at VDD/2 on the CLKOUT pins of the device			700	pS
Cycle-to-Cycle Jitter 7,8	Loaded outputs			±200	pS
PLL Lock Time <sup>8</sup>	Stable power supply, valid clock presented on CLKIN pin			1.0	mS

Note: 5. CLKIN input has a threshold voltage of VDD/2
6. Parameter is guaranteed by design and characterization. Not 100% tested in production

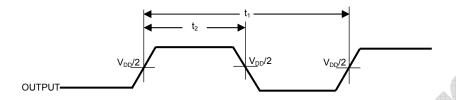
Note: 7. All parameters specified with 10pF loaded outputs.

8. Parameter is guaranteed by design and characterization. Not 100% tested in production

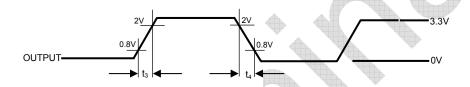


### **Switching Waveforms**

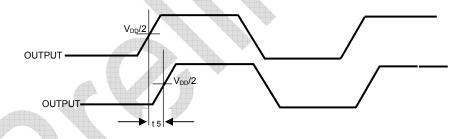
# **Duty Cycle Timing**



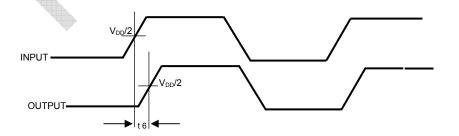
# All Outputs Rise/Fall Time



# **Output - Output Skew**

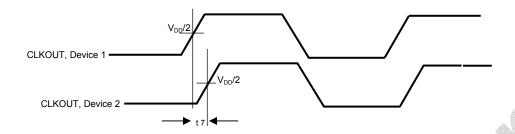


# **Input - Output Propagation Delay**

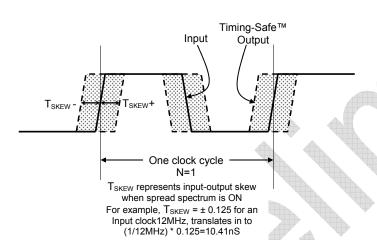




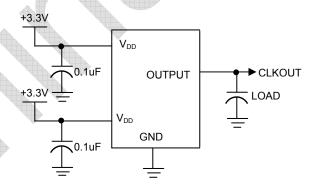
#### **Device - Device Skew**



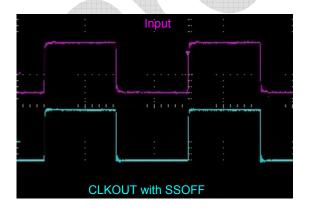
### **Input-Output Skew**

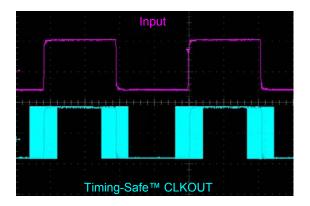


### **Test Circuit**



# A Typical example of Timing-Safe™ waveform

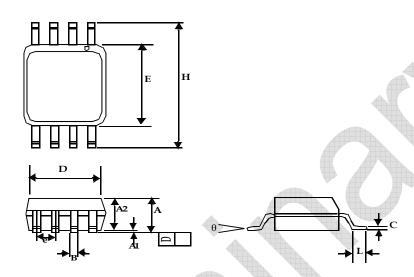






# **Package Information**

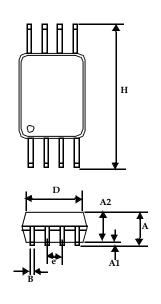
# 8-lead (150-mil) SOIC Package

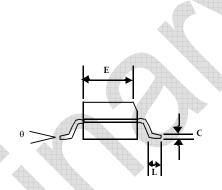


	Dimensions				
Symbol	Inc	hes	Millimeters		
	Min	Max	Min	Max	
A1	0.004	0.010	0.10	0.25	
Α	0.053	0.069	1.35	1.75	
A2	0.049	0.059	1.25	1.50	
В	0.012	0.020	0.31	0.51	
C	0.007	0.010	0.18	0.25	
D	0.193	BSC	4.90 BSC		
E	0.154	BSC	3.91 BSC		
е	0.050	BSC	1.27	BSC	
Н	0.236	BSC	6.00 BSC		
L	0.016	0.050	0.41	1.27	
θ	0°	8°	0°	8°	



# 8-lead TSSOP (4.40-MM Body)

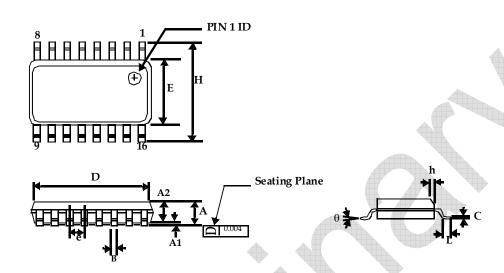




	Dimensions					
Symbol	Inc	hes	Millimeters			
	Min	Max	Min	Max		
Α		0.043		1.10		
A1	0.002	0.006	0.05	0.15		
A2	0.033	0.037	0.85	0.95		
В	0.008	0.012	0.19	0.30		
c	0.004	0.008	0.09	0.20		
D	0.114	0.122	2.90	3.10		
E	0.169	0.177	4.30	4.50		
е	0.026 BSC		0.65 BSC			
Н	0.252 BSC 6.40 B		BSC			
L	0.020	0.028	0.50	0.70		
θ	0°	8°	0°	8°		



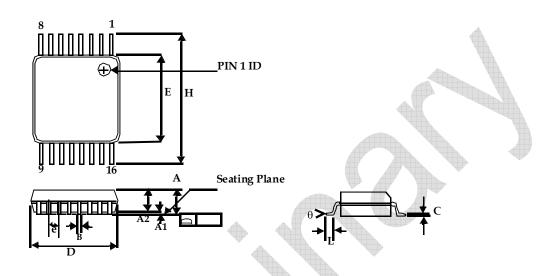
# 16-lead (150 Mil) Molded SOIC Package



	Dimensions					
Symbol	Inc	hes	Millimeters			
	Min	Max	Min	Max		
Α	0.053	0.069	1.35	1.75		
A1	0.004	0.010	0.10	0.25		
A2	0.049	0.059	1.25	1.50		
В	0.013	0.022	0.33	0.53		
C	0.008	0.012	0.19	0.27		
D	0.386	0.394	9.80	10.01		
E	0.150	0.157	3.80	4.00		
е	0.050	BSC	1.27	BSC		
Н	0.228	0.244	5.80	6.20		
h	0.010	0.016	0.25	0.41		
L	0.016	0.035	0.40	0.89		
θ	0°	8°	0°	8°		



# 16-lead TSSOP (4.40-MM Body)



	Dimensions					
Symbol	Inch	nes	Millimeters			
	Min	Max	Min	Max		
Α		0.043		1.20		
A1	0.002	0.006	0.05	0.15		
A2	0.031	0.041	0.80	1.05		
В	0.007	0.012	0.19	0.30		
C	0.004	0.008	0.09	0.20		
D	0.193	0.201	4.90	5.10		
E	0.169	0.177	4.30	4.50		
е	0.026	BSC	0.65 BSC			
Н	0.252 BSC		6.40 BSC			
L	0.020	0.030	0.50	0.75		
θ	0°	8°	0°	8°		



# **Ordering Code**

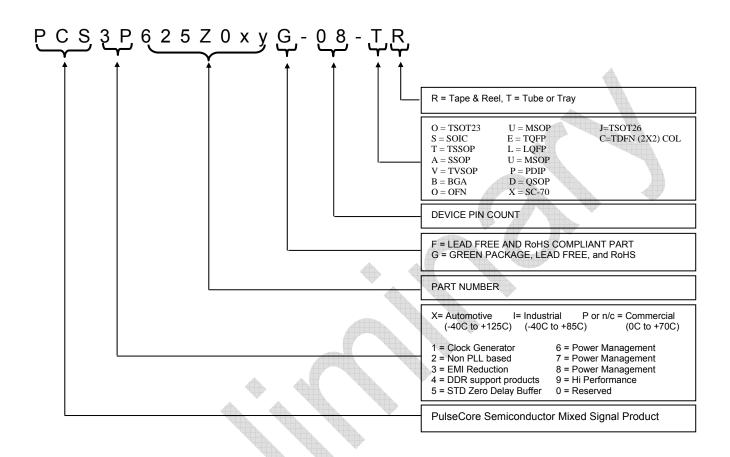
Ordering Code	Marking	Package Type	Temperature
PCS3P625Z0xyG-08-ST	3P625Z0xyG	8-pin 150-mil SOIC-TUBE, Green	Commercial
PCS3I625Z0xyG-08-ST	3I625Z0xyG	8-pin 150-mil SOIC-TUBE, Green	Industrial
PCS3P625Z0xyG-08-SR	3P625Z0xyG	8-pin 150-mil SOIC-TAPE & REEL, Green	Commercial
PCS3I625Z0xyG -08-SR	3I625Z0xyG	8-pin 150-mil SOIC-TAPE & REEL, Green	Industrial
PCS3P625Z0xyG-08-TT	3P625Z0xyG	8-pin 4.4-mm TSSOP - TUBE, Green	Commercial
PCS3I625Z00xyG -08-TT	3I625Z0xyG	8-pin 4.4-mm TSSOP - TUBE, Green	Industrial
PCS3P625Z0xyG-08-TR	3P625Z0xyG	8-pin 4.4-mm TSSOP - TAPE & REEL, Green	Commercial
PCS3I625Z0xyG -08-TR	3l625Z0xyG	8-pin 4.4-mm TSSOP - TAPE & REEL, Green	Industrial
PCS3P625Z0xyG -16-ST	3P625Z0xyG	16-pin 150-mil SOIC-TUBE, Green	Commercial
PCS3I625Z0xyG -16-ST	3I625Z0xyG	16-pin 150-mil SOIC-TUBE, Green	Industrial
PCS3P625Z0xyG -16-SR	3P625Z0xyG	16-pin 150-mil SOIC-TAPE & REEL, Green	Commercial
PCS3I625Z0xyG -16-SR	3I625Z0xyG	16-pin 150-mil SOIC-TAPE & REEL, Green	Industrial
PCS3P625Z0xyG -16-TT	3P625Z0xyG	16-pin 4.4-mm TSSOP - TUBE, Green	Commercial
PCS3I625Z0xyG -16-TT	3I625Z0xyG	16-pin 4.4-mm TSSOP - TUBE, Green	Industrial
PCS3P625Z0xyG -16-TR	3P625Z0xyG	16-pin 4.4-mm TSSOP - TAPE & REEL, Green	Commercial
PCS3I625Z0xyG -16-TR	3I625Z0xyG	16-pin 4.4-mm TSSOP - TAPE & REEL, Green	Industrial

Note: x=5 / 9; y=B / C





# **Device Ordering Information**



Licensed under US patent #5,488,627, #6,646,463 and #5,631,920.





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Document Version: 0.1

Note: This product utilizes US Patent #6,646,463 Impedance Emulator Patent issued to PulseCore Semiconductor, dated 11-11-2003

Many PulseCore Semiconductor products are protected by issued patents or by applications for patent

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